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RoHS Reach Halogen Free Pb Free

交货型号	C2012X6S0G226MT****	
用途	一般等级	4
特点	General 一般(~75V)	T T
系列	C2012 [EIA 0805]	
状态	▲ 量产体制(新设计非推荐) 推荐代替型号 : <u>C2012X7S0J226M125AC</u> (不保证其兼容性。)	B

	尺寸
长度(L)	2.00mm ±0.20mm
宽度(W)	1.25mm ±0.20mm
厚度(T)	0.85mm ±0.15mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)
推存,序益仰向(FA)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
기표 위카가 꽤 가마 지 D)	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
3年477年71年7月1日(1 6)	0.90mm to 1.20mm(Reflow Soldering)

	电气特性	
电容	22 μ F ±20%	
	4VDC	
温度特性	X6S(±22%)	
	10%	
	4M Ω	

	其他
焊接方法	流体
件按刀 伝	回流
AEC-Q200	NO
包装形式	纸编带 (180mm卷筒)
包装个数	4000pcs

 $!\ \mbox{Images}$  are for reference only and show exemplary products.

 $!\ \mbox{This PDF}$  document was created based on the data listed on the TDK Corporation website.

! All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

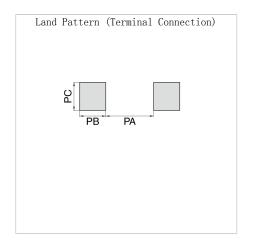
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## Associated Images



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